

LSI LOGIC L64853 SBus DMA Controller **Technical** Manual MD70-000109-99 A

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The L64853 SBus DMA Controller Technical Manual is written for two audiences: system-level programmers and hardware designers. The manual assumes readers are familiar with computer architecture, software and hardware design, and design implementation. It also assumes readers have access to additional information about the SPARC workstation—in particular, the SPARC SBus specification, which can be obtained from Sun Microsystems.

This manual is organized in a top-down sequence; that is, the earlier chapters describe the purpose, context, and functioning of the L64853 DMA Controller from an architectural perspective, and later chapters provide implementation details.

Content and Organization for System-Level Programmers—For the system-level programmer, this manual briefly describes the SPARC workstation architecture, then fully describes the function of the chip with respect to the architecture.

Chapter 1 describes the basic features and operation of the L64853 DMA Controller and the chip's relationship to the other SPARC chips. Chapter 2 describes the internal, programmable registers of the L64853, and it describes how to access both internal and external registers. Chapter 3 further describes the operation of the E and D channels. To aid in implementation of the chip in a typical environment, Chapter 6 shows how to access the Emulex SCSI Processor (ESP-100) and the AMD LANCE Ethernet AM7900 internal registers.

Content and Organization for Hardware Designers—For the hardware designer, this manual provides the electrical, logical, and mechanical data necessary to integrate the L64853 DMA Controller into the SPARC workstation.

Chapter 4 describes the data transfer cycles for the D and E channels and the signals used by the L64853 DMA Controller during read and write operations. Chapter 5 provides the AC, DC, environmental, and mechanical specifications for the L64853.

This manual is divided into six chapters:

- Chapter 1: Introduction describes the basic features and operation of the L64853 DMA Controller, showing its relationship to the other SPARC system elements.
- Chapter 2: Registers describes the types of registers available on the L64853 DMA Controller and how internal and external registers are accessed.
- Chapter 3: Operation of the D and E Channels describes the DMA Controller's D and E channels, which are used with peripheral chips, and modes of operation on the Sbus, which is used for data transfers between the peripheral subsystems and main memory.
- Chapter 4: Interface Description describes the signals used by the L64853 and the data transfer cycles for the D and E channels.
- Chapter 5: Specifications provides the AC, DC, environmental, and mechanical specifications for the L64853.

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• Chapter 6: Applications describes the types of SPARC workstation applications that the L64853 DMA Controller fits into and provides interface examples to Emulex SCSI Processor (ESP-100) and to an AMD Local Area Network Controller (AM7990).

Related Publications

The SBus Specification, Revision A (September 1989)
Sun Microsystems, 2550 Garcia Avenue, Mountain View, CA 94042

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Chapter 1: Introduction

This chapter describes the basic capabilities and operation of the L64853 DMA Controller, showing its relationship to the other SPARC-system components. Its intended readers include system-level programmers and hardware designers, for whom this chapter is particularly important.

1.1 General Description of the L64853 SBus DMA Controller

The L64853 SBus DMA Controller provides a complete SBus interface for SBus peripheral subsystems. The L64853 provides two independent DMA channels, a 16-bit channel and an 8-bit channel. The L64853, implemented in a 1.5-micron CMOS process and manufactured by LSI Logic Corporation, is packaged in an inexpensive, 120-pin, plastic quad flat package (PQFP).

The L64853's two channels support DMA for use in applications that require operation as an SBus master. Such applications include:

- Ethernet controllers
- 8-bit controllers

The L64853's two channels can also be used for applications that rely on programmed I/O and thus use only the L64853's SBus slave capability. Such applications include:

- Serial ports
- Analog-to-Digital converters

The L64853's 8-bit channel is called the D channel. The 16-bit channel is called the E channel. The L64853 generates, upon request from devices attached to either channel, sequences of SBus data transfers (that is, reads or writes) between the peripheral controller and main memory. To perform this function, the L64853 can become an SBus master through the use of the SBus Request and Grant signals. (In SBus terminology, the L64853 is a "DVMA Master" that is, it generates virtual addresses on the SBus data lines and employs the SBus controller's Memory Management Unit (MMU) to translate these virtual addresses into physical addresses. (See the Sun SBus Specification from Sun Microsystems for more details.)

The L64853 is programmable. Programs running on the system CPU may set parameters that govern the transfers performed by the L64853 and also read the current status of the chip. This programming is achieved by writing and reading internal registers on the L64853 (and also on the two peripheral controllers). In order to permit this writing and reading, the L64853 can become an *SBus slave* when the CPU asserts the Slave Select signal specific to the L64853. While acting as an SBus Slave, the L64853 can also be used by the CPU as a conduit to the two peripheral controller chips, thus allowing the CPU to program them.

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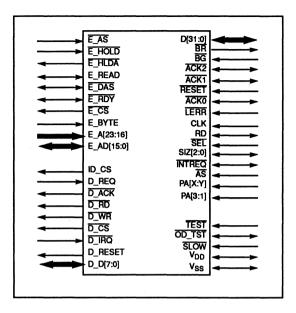


Figure 1.1 L64853 Logic Symbol

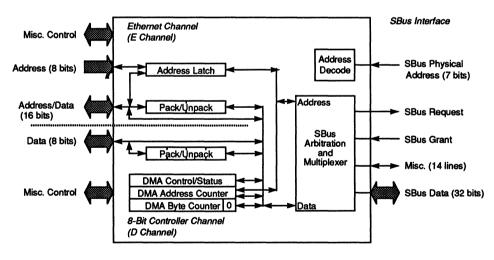


Figure 1.2 L64853 Internal Block Diagram

Architecture

The principal components of the L64853 are its two functionally distinct DMA channels and its SBus interface with associated bus arbitration logic. Figure 1.1, illustrating the L64853 signals, reflects this organization, as does Figure 1.2, which shows the chip's internal architecture. Chapter 4 describes the L64853 DMA Controller's signals.

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The architecture of the chip can be summarized by examining its registers. The E channel ("E" channel) has three registers:

- An Address Latch Register for temporarily storing memory addresses from the E channel controller before they are put on the SBus
- A Pack Register and an Unpack Register for buffering 32-bit SBus words into bytes or 16-bit half-words

The 8-bit I/O controller channel ("D" channel) has five registers:

- A Pack Register and an Unpack Register for buffering 8-bit transfers from the peripheral controller into 32-bit transfers on the SBus
- A Control/Status Register containing programmable parameters and status fields
- An Address Count Register for holding the memory address of the current word being transferred on the SBus
- A Byte Count Register for counting down the number of bytes transferred during a transfer of a block of data

Channel Operations

As mentioned, the L64853 becomes an SBus master to perform reads and writes between the peripheral controllers and main memory. Alternatively, the L64853 becomes an SBus slave, in which mode register reads and writes are performed. All channel operations are ultimately governed by the SPARC environment in which the L64853 is implemented. Section 1.2 and Chapter 3 describe the most general-case use of the L64853. Later chapters on signals and timing specifications provide detailed information on AC and DC characteristics. Examples of using the AMD LANCE controller and the Emulex ESP-100 appear in Chapter 6.

1.2 Key Features

As its key features, the L64853 offers:

- Support for an 8- or 16-bit peripherals
- Packing/unpacking of 32-bit SBus words into bytes or 16-bit half-words for use by the peripheral controllers
- Support for byte, half-word, or word transfers on the SBus
- Operation in virtual address space with the SPARC MMU providing logical-to-physical address translations
- · Support for rerun acknowledgments
- Inclusion of 24-bit address and data counters
- Packaging in a low-cost 120-pin plastic flat pack

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• Use of a single clock input

These features are described in more detail in subsequent chapters.

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Chapter 2: Registers

This chapter first discusses the kinds of registers available on the L64853, then describes the chip's programmable and ID registers, and ends by telling how to access both internal and external registers. It is intended primarily for system programmers.

2.1 Overview of L64853 Internal Registers

The L64853 has three types of internal registers:

1. Programmable registers

The L64853's three *programmable registers* are used to control the operation of the chip and to contain status information. They are the following:

- DMA Control/Status Register
- DMA Address Counter
- DMA Byte Counter.

2. ID Register

The ID Register is pre-programmed with a read-only value unique to the L64853 chip.

3. Pack and Unpack Registers

Both the D and the E channel have a *Pack Register* and an *Unpack Register*. These registers are used to buffer data transfers between the 32-bit SBus and the 8-bit D channel or the 16-bit E channel.

Because the operation of the Pack/Unpack Registers is entirely automatic, it is described only in the context of channel operations (Chapter 3). The rest of this section focuses on the programmable registers and the ID Register.

2.2 Internal Programmable Registers

The three internal programmable L64853 registers are defined in this section. Chapter 3 provides additional details about field and bit operations of these registers while the D and E channels are operating.

These registers contain control and status information. The internal programmable L64853 registers are used solely to control the D channel and the SBus. In contrast, the E channel is controlled entirely by external registers on the E peripheral controller itself.

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DMA Control/Status Register

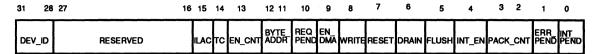


Figure 2.1 Control/Status Register (DMA CSR)

The 32-bit Control/Status Register (shown in Figure 2.1 above) directs the functioning of the D channel interface and also reports the status of that channel. The functions of the individual fields are given in the following description. The set state = 1, the clear state = 0.

INT_PEND Interrupt Pending Bit 0 (Read Only)

This bit is set automatically to indicate a pending interrupt (that is, whenever TC is set or when $\overline{D_{IRQ}}$ is asserted); otherwise, it is clear.

NOTE: Throughout this manual, a signal that is asserted when its voltage is low is indicated by an overbar; for example, $\overline{D_IRQ}$ refers to the D channel DMA INTERRUPT REQUEST, active low signal. The underbar is a connective to the second part of the signal name.

ERR_PEND Error Pending Bit 1 (Read Only)

This bit is set when an error condition occurs during a D channel memory access (for example, a parity error, protection violation, or timeout). ER-R_PEND causes an interrupt (INTREQ asserted) if INT_EN is set. DMA transfers over the SBus are stopped when this condition occurs. ERR_PEND is reset whenever FLUSH is set.

PACK_CNT Pack Count Bits 3-2 (Read Only)

This field contains the number of bytes in the D channel Pack/Unpack Register. The field is cleared by setting FLUSH or DRAIN; however, FLUSH merely clears the field, whereas DRAIN writes the contents of the Pack/Unpack Register to memory and then clears the field.

INT_EN Interrupt Enable Bit 4 (Read/Write)

When set, this bit enables the passing through of D channel interrupts (D_IRQ to SBus INTREQ), as well as passing through interrupts from ERR_PEND and TC.

FLUSH Flush Buffer Bit 5 (Write Only)

When set, this bit causes PACK_CNT, ERR_PEND, and TC to be reset. This bit always reads as clear.

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DRAIN

Drain Buffer

Bit 6 (Read/Write)

When set, this bit causes any bytes yet in the D channel Pack Register to be written out to SBus memory; then it clears PACK_CNT. This bit clears itself automatically.

RESET

Reset DMA

Bit 7 (Read/Write)

In its set state, this bit acts as a hardware reset, putting the L64853 into the following initial state: ERR_PEND, INT_EN, FLUSH, DRAIN, WRITE, EN_DMA, REQ_PEND, EN_CNT, TC, PACK_CNT, and BYTE ADDR are all clear; and RESET is set.

WRITE

Read/Write

Bit 8 (Read/Write)

This bit determines the direction of the D channel DMA transfer. When set, the flow is to memory (memory write); when cleared, the flow is from memory (memory read).

EN DMA

Enable DMA

Bit 9 (Read/Write)

When set, this bit allows the L64853 to respond to DMA requests by the D channel controller,

REQ PEND

Request Pending

Bit 10 (Read Only)

This bit is set when the D channel controller requests a DMA transfer and remains set as long as D channel DMA transfers are taking place. Do not set RE-SET or FLUSH while this bit is set. The driver should poll this bit until it is cleared and then take any necessary clean-up action by setting the FLUSH or DRAIN bits.

BYTE ADDR

Byte Address

Bits 12-11 (Read)

This two-bit counter contains the lowest two bits of the address of the next byte to be accessed by the D channel controller. Note that the contents of this counter may be different from the address in the DMA Address Counter Register, which contains the address of the next SBus access.

EN_CNT

Enable Counter

Bit 13 (Read/Write)

The set state enables operation of the internal Byte Counter Register. The set state also enables operation of the TC bit.

TC

Terminal Count

Bit 14 (Read Only)

The set state of this bit reveals that the byte counter has expired. That is, TC is set when a byte count makes a transition from 000001 to 000000. TC is cleared only by the SBUS RESET signal or by setting FLUSH.

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ILACC ILACC 79C900 Bit 15 (Read/Write)

This bit should be cleared by software. It is present for historical reasons.

Reserved Bits 27-16 (Read Only)

These bits are reserved for future enhancements; they are always clear.

DEV ID Device ID Bits 31-28 (Read Only)

Future revisions of the L64853 may be specified using these bits. For the current implementation, the field is set to 1000 (that is, 8).

DMA Address Counter

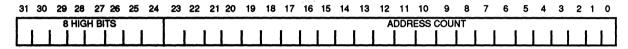


Figure 2.2 DMA Address Counter (DMA_ADDR)

The 32-bit Address Counter (Read/Write; shown in Figure 2.2 above) is used to contain the starting virtual address of a D channel DMA transfer to or from SBus memory. The lower three bytes are an auto-incrementing counter: a 24-bit counter that increments by 1, 2, or 4 during write transfers (to memory), depending on the size of the data item written. During DMA transfers (from memory), the counter always increments by 4.

The upper byte is an 8-bit register that contains the high-order byte of the virtual address. It does not auto-increment; therefore, DMA transfers are limited to 16 MB and may not cross a 16 MB address boundary.

After a RESET, the Address Counter contains an indeterminate value.

DMA Byte Counter

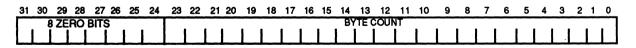


Figure 2.3 DMA Byte Counter (DMA_BCNT)

The 24-bit Byte Counter (Read/Write; shown in Figure 2.3) is used to hold the number of bytes remaining in the current D channel DMA transfer. The counter decrements to 0, at which point it generates an interrupt if INT_EN is set in the CSR. This register is activated by setting EN_CNT in the CSR. The value in this register after RESET is indeterminate.

Even though this is a 24-bit register, it is read as a full word (32-bit) value. The upper byte always reads as zero.

Internal ID Register

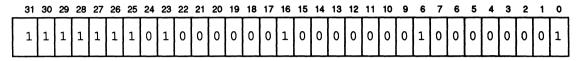


Figure 2.4 ID Register

Each SBus device can be identified by software through a unique ID number supplied by the user of that device. The ID for the L64853 is hardwired to the 32-bit value: FE810101 (see Figure 2.4). Refer to *The SBus Specification* for details on using the External ID Register.

2.3 Addressing Internal and External Registers

Any SBus peripheral device that is built using the L64853 will contain two types of configuration and control registers: the internal L64853 registers described in Section 2.2 and the external registers in the peripheral controllers that are attached to the L64853's two channels.

The system addresses that specify the internal or external registers are determined by the implementation of the SBus Controller and the way that the hardware designer connects the physical address signals.

The SBus uses a geographical addressing scheme that assigns ranges of address to each SBus connector. When the SBus controller detects access to a particular range, it asserts the SEL signal dedicated to the related connector.

When the L64853's SEL input is asserted by the SBus Controller, the L64853 uses four address inputs to further decode the address present on SBus signals PA[27:0]. These four L64853 inputs are PA[X:Y] and PA [3:2]. The PA[X:Y] signals are connected to two of the SBus's 28 physical address lines, PA[27:0]. (On the SPARCstation 1, these two lines are PA[23:22].) The L64853 uses PA[X:Y] to select which category of registers is being accessed according to Table 2.1. The size of the data item that must be transferred over the SBus (specified by SIZ[2:0]) is also shown for each category of register.

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PA[X:Y]	Addressed Register Type	Size
00	Internal ID Register	Word
01	Internal programmable registers	Word
10	D channel registers (external)	Byte
11	E channel registers (external)	Half

Table 2.1 Accesses by Register Type

Two other physical address lines PA[3:2] are normally connected to the PA[3:2] pins of the L64853, and, when the PA[X:Y] value is 01, these lines are used to select a particular internal programmable register (see Table 2.1).

PA[3:2]	Addressed Register
00	DMA Control/Status Register
01	DMA Address Register
10	DMA Byte Count Register
11	Reserved for Testing

Table 2.2 Internal Register Addresses

Other physical address lines are wired directly to the two peripheral controllers and are used in an implementation-dependent manner to select specific external registers on these two chips.

Note: PA1 is used by the L64853 to steer the appropriate (upper or lower) half-word of data to the E channel peripheral during slave accesses.

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Chapter 3: Operation of the D and E Channels

This chapter describes the functioning of the D and E channels. First, the two SBus operational modes are introduced. Next, the two basic kinds of operations (DMA Reads and Writes and Register Reads and Writes) are described in step-by-step fashion. Finally, details pertinent to the individual channels are provided. This chapter is directed particularly to system programmers.

3.1 Modes of Operation

The L64853 supports two basic modes of operation:

· Master mode

In Master mode, the L64853 is an SBus DVMA Master and performs DMA reads and writes. The L64853 generates virtual addresses on the SBus data lines, which are translated into physical addresses by the SBus controller's MMU, and transfers data between memory and a peripheral controller.

· Slave mode

In Slave mode, the CPU is the SBus master, and it performs register reads and writes of the L64853 as an SBus slave. The physical address lines of the SBus access the internal registers of the L64853 and those of the two peripheral controllers, using a register addressing scheme that is implementation dependent.

The basic operations of both the E and D channels are DMA Reads and Writes – executed when the L64853 is in Master mode – and Register Reads and Writes, executed when the L64853 is an SBus Slave.

The main difference between the two channels is that the E channel is programmed entirely through the external registers – none of the internal L64853 registers affect the E channel.

DMA transfers are accomplished by the coordinated activity of all chips in the system: the peripheral controller, the L64853, the CPU, the SBus controller, and the memory controller. First the procedure for a write operation is presented, then differences required for a read are noted.

3.2 DMA Reads and Writes (Master Mode)

The following are the steps of the write operation:

- 1. One of the two peripheral controllers requests a DMA transfer, using either the Hold signal (E_HOLD in the E channel) or Request signal (D_REQ in the D channel).
- 2. The L64853 acknowledges the requesting peripheral controller, using either the Hold Acknowledge signal (E_HLDA in the E channel) or Acknowledge signal (D_ACK in the D channel), thus prompting the controller to begin the data write operation.
- 3. (E channel only) The L64853 receives a 24-bit address from the E channel controller on the E_AD[15:0] and E_A[23:16] lines into the Address Latch Register. This address serves as the lowest 24 bits of the memory address to which the data is

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written. This address was set up by an earlier slave-mode transfer between the CPU and the E channel controller, via the L64853.

- 4. The L64853 loads 8-bit or 16-bit data items from the peripheral controller into the appropriate Pack/Unpack Register until the register is full, using the E_AD[15:0] lines (E channel) or D_D[7:0] lines (D channel).
- 5. The L64853 requests control of the SBus using the Bus Request signal (\overline{BR}) ; control is granted by the SBus Controller with the Bus Grant signal (\overline{BG}) .
- 6. The L64853 outputs a 32-bit virtual address from either the Address Latch Register (E channel) or the Address Counter Register (D channel) onto the SBus data lines D[31:0]. In an E channel operation, the 32-bit address is formed by appending FF as the high-order byte to the 24-bit address in the Address Latch Register. (The address in the Address Count Register must have been previously set up by an earlier slave mode transfer from the CPU.) If both D and E channels need the SBus simultaneously, the E channel has priority.
- 7. The SBus Controller's MMU translates this virtual address into a 28-bit physical address on the SBus physical address lines PA[27:0].
- 8. The L64853 outputs the contents of the appropriate Pack/Unpack Register onto the SBus data lines D[31:0] for transfer to the memory controller, which sends the data to the memory array.

Read operations are very similar:

- 1. One of the two peripheral controllers requests a DMA transfer, using either the Hold signal (E_HOLD in the E channel) or Request signal (D_REQ in the D channel).
- 2. (E channel only) The L64853 acknowledges the E channel peripheral using E_HLDA, then waits for E_DAS to be asserted. When E_DAS is asserted, the L64853 requests control of the SBus.
 - On the D channel, if the Unpack Register is empty (no bytes left over from a previous DMA read operation), the L64853 requests control of the SBus without providing acknowledgment (D_ACK) to the D channel peripheral. If the Unpack Register has any valid data remaining, the L64853 asserts (D_ACK) and begins transferring the data to the D channel peripheral.
- 3. When the L64853 gets control of the SBus (BG is asserted), the L64853 outputs the address of the data requested, either from the Address Latch Register (E channel) or Address Counter (D channel), onto the SBus data lines.
- 4. The SBus controller's MMU translates this virtual address into a 28-bit physical address on the SBus physical address lines PA[27:0].
- 5. The L64853 reads the SBus data lines D[31:0] when the data comes back from memory and transfers their contents to the appropriate Pack/Unpack Register.

6. L64853 sends 8-bit or 16-bit data items to the peripheral controller from the appropriate Unpack Register until the register is empty, using the E_AD[15:0] lines (E channel) or D_D[7:0] lines (D channel).

The above summary omits some signals, in particular the Address Strobes (\overline{E} _AS and \overline{AS}), and the Read and Write Strobes (RD, E_READ, \overline{D} _RD, \overline{D} _WR). Their operation is covered in Chapter 4 (refer particularly to the timing diagrams). When all the data bytes have been transferred, the L64853 can generate an interrupt that informs the CPU that the operation is complete (this occurs only when the Byte Counter is zero and interrupts are enabled).

3.3 Register Reads and Writes (Slave Mode)

Register reads and writes allow the CPU to read status conditions and to set up data transfer parameters. Register reads and writes are simpler to describe than DMA transfers, because the CPU is the Bus Master throughout, and the L64853 is passive.

The following are the steps for a register read or write operation:

- 1. The CPU executes a LOAD or STORE instruction using the system-dependent address that causes the Slave Select signal (SEL) connected to the L64853 to be asserted.
- 2. The SBus controller converts the CPU's LOAD or STORE address into an active SEL signal for the L64853 and a pattern on the physical address lines PA[27:0], along with several other active strobes specifying an address and a read or write (see the timing diagram in Chapter 4: Interface Description.)
- 3. The L64853 recognizes that the read or write access is intended for itself (the Slave Select is specific), and interprets the pattern on the physical address lines to determine which register (internal, external E channel controller, or external D channel controller) is the intended target of the read or write. (Refer to Chapter 2: Registers for the assignment of physical addresses to L64853 internal registers.) Chapter 6: Applications describes the register addresses for the external registers on the SPARCstation 1.
- 4. If the target register is internal to the L64853 (that is, a 32-bit register), the data is either read from the intended register to the data lines D[31:0] (reads) or written from the data lines to the intended register (writes).
- 5. If the target register is external, the data transfer over the SBus must be either byte (D channel) or half word (E channel). The L64853 passes the data between the SBus and the target controller without any buffering in the relevant Pack/Unpack Register. For the E channel, the data is transferred over the E_AD[15:0] lines to or from a 16-bit register in the E channel controller; for the D channel, the data is transferred over the D_D[7:0] lines to or from an 8-bit register in the D channel controller. To accomplish this transfer, the L64853 also asserts various strobes in the D or E channels (refer to Chapter 4: Interface Description for timing diagrams).

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- 6. Finally, the L64853 asserts the SBus Acknowledge signal (ACK2 in almost all cases), thus informing the SBus controller that the slave-mode operation has completed.
- 7. If the D or E channel is busy transferring data to or from the Pack/Unpack Register when the CPU selects that channel, the DMA chip will assert Rerun Acknowledgment.

3.4 Specifics of D Channel Operation

For write operations (to memory) four 8-bit D channel transfers are converted into one 32-bit SBus cycle, whenever possible, through use of the Pack Register. However, initial bytes in the transfer that are not word-aligned ("leading fragments") are transferred to memory as bytes until the address reaches a word boundary; then the SBus transfers are by words. Final bytes that do not fill a word ("trailing fragments") must be explicitly written to memory by setting the DRAIN bit in the DMA Control/Status Register.

The 2-bit counter (PACK_CNT) in the DMA Control/Status Register tracks the number of bytes stored in the internal Pack Register during DMA read or write transfers. During writes, whenever the PACK_CNT = 3 and another byte is accepted, a word write is scheduled with the SBus interface. If a DMA transfer completes, leaving a non-word fragment in the Pack Register, this counter is used by the hardware to determined how many bytes to write to the SBus when DRAIN is set.

The DMA Address Register, which contains the memory address of the DMA transfer, always points at the next memory location to be accessed. When the direction of a DMA transfer is to memory (writes), the counter is incremented by the size of the write (1 byte or 4 bytes) upon completion of the transfer.

When the direction of the DMA transfer is from memory (reads), the address is always incremented by 4 (32 bits being received simultaneously). All DMA reads are thus word-length, and all are word-aligned (that is, the lowest two bits of the address are always zero).

Read DMA operations always transfer 32 bits into the Unpack Register, from which four consecutive bytes are unpacked and written to the D channel controller. Every time the byte address crosses a word boundary, a new word is read from memory, the address is incremented by 4, and the PACK_CNT field in the DMA Control/Status Register is set to 3 (that is, the first byte is sent to the peripheral controller immediately). The next three transfers to the D channel controller use data from the Unpack Register. Each transfer causes PACK_CNT to be decremented. Setting FLUSH in the DMA Control/Status Register or writing a new address in the DMA Address Register causes the L64853 to mark any data left in the Unpack Register during a read as invalid and forces a new memory access.

Since the DMA Address Register is incremented by the SBus interface of the L64853 when it makes SBus transfers, this address may occasionally disagree with the value in the BYTE_ADDR field of the DMA Control/Status Register. (This 2-bit byte counter always contains the lowest two bits of the next byte location that the D channel controller will access.) BYTE_ADDR increments by 1 each time a byte is transferred between the peripheral controller and the L64853. BYTE_ADDR is loaded at the same time an address is loaded into the DMA Address Register, and it receives the two least-significant bits of the address.

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Termination and Interrupts

Three control bits in the DMA Control/Status Register are used by the device driver to terminate a transfer: EN_DMA, DRAIN, and FLUSH. Clearing the EN_DMA bit causes new DMA requests from the D channel controller to be ignored. The current DMA transfer, however, is unaffected by this bit. EN_DMA can be set or cleared at any time without affecting a transfer currently in progress.

DRAIN sends all data currently in the Unpack Register to memory and clears PACK_CNT. It is useful when a transfer completes and the data for transfer to memory does not fill the 32-bit word. DRAIN can also be used to leave a transfer that has been stopped with EN_DMA in a clean state so that it can be restarted later. Because a DRAIN sequence leaves the DMA Address Register pointing to the byte address beyond the last byte or word written, the address counter must be reloaded prior to the next transfer so that the byte counter, BYTE_ADDR, is set correctly.

FLUSH provides a mechanism for the driver to clean up the state of a transfer (clear PACK_CNT) without draining the packed data to memory. It is also used to clear the ERR_PEND indicator, allowing error conditions to be cleared cleanly.

The RESET bit of the DMA Control/Status Register generates an external reset signal that resets all D channel interface logic (state machines). If any memory activity is still pending, as indicated on the REQ_PEND bit, do *not* set RESET and/or FLUSH. If REQ_PEND is asserted, the driver should poll it until it is de-asserted. Similarly, writing to the DMA Address Register, changing the WRITE bit in the DMA Control/Status Register, or writing the BYTE_CNT Register when the REQ_PEND bit is set puts the L64853 into an unknown state.

The INT_EN bit is provided to enable or disable the generation of an interrupt on the SBus, whether these interrupts arise from interrupts from the D channel controller, or from errors during memory accesses, or completion of a transfer. Interrupts from the D channel controller are visible as INT_PEND in the DMA Control/Status Register. An error condition that occurs during a memory access (for example, a parity error, timeout, or protection error) causes the ERR_PEND bit to be set. Similarly, expiration of the BYTE_CNT when enabled causes the INT_PEND bit to be set. Any of these conditions can cause the L64853 to generate an SBus interrupt, if interrupts are enabled by INT_EN.

Use of the Byte Counter Register

The Byte Counter Register can be used with some D channel controllers. To work with this Register, perform the following operations:

- 1. Load the DMA virtual address into a DMA Address Register.
- 2. Load the byte count into a DMA Byte Counter.
- 3. Load the peripheral device with relevant commands.
- 4. Load the DMA Control/Status Register with enables and direction bits (EN_DMA, EN_CNT, WRITE).

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Data is transferred until the byte count expires at which point the TC Flag in the DMA Control/Status Register is set and an interrupt is generated, if enabled by INT_EN.

5. After the CPU has serviced the interrupt and is ready to start another DMA operation, set FLUSH and begin again with Step 1.

3.5 Specifics of E Channel Operation

As mentioned earlier, the E channel, like the D channel, supports DMA read and write operations, as well as read and write operations to the external Registers of the channel controller. The E channel, however, is programmed through the external Registers. The only Registers on the L64853 dedicated to the E channel are the Address Latch and the E channel Pack/Unpack Registers.

During a DMA read or write operation, the E channel controller provides the memory address to which the DMA data is to be written. This 24-bit address from the controller is transferred over the E_A[23:16] and E_AD[15:0] lines to the Address Latch on the L64853. The L64853 then appends a high-order 8-bit value FF to this 24-bit address to create the 32-bit SBus virtual address, which it sends out on the SBus data lines D[31:0] during a DVMA Master cycle.

The data on the SBus during the data transfer portion of the DVMA Master cycle is transferred between memory and the E channel Unpack Register. DMA transfers from memory (reads) always transfer 32 bits into the Unpack Register, from which two consecutive half-words are unpacked and written to the E channel controller. Every time the address crosses a word boundary a new word is read from memory. The next transfer to the E channel controller uses data from the Unpack Register.

When the E channel controller is transferring data to memory, the data is packed, unless the access is either not word-aligned, and there is no data buffered, or the data involved is a single byte, in which case the L64853 transfers the data to memory immediately. Data that is word-aligned is held pending the next sequential write, assuming it is a part of the same E channel controller burst transfer, whereupon the entire word is transferred to memory.

Any data in the Pack Register is transferred to memory whenever \overline{E} _HOLD is deasserted. An example of such an event would be a single half-word message descriptor write by the E channel controller.

The E channel supports burst mode transfers (that is, multiple half-word transfers before the $\overline{E_HOLD}$ signal is released). At the end of read bursts, data left in the Pack/Unpack Register is discarded. At the end of write bursts, data remaining in the Pack Register is automatically written to memory.

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Chapter 4: Interface Description

This chapter describes the signals used by the L64853 and the data transfer cycles for the D and E channels. This information is useful primarily for hardware designers.

4.1 Pin Summary

Figure 4.1 shows the pin name abbreviations associated with each pin of the L64853. Table 4.1 provides the signal name, abbreviation, and pin number.

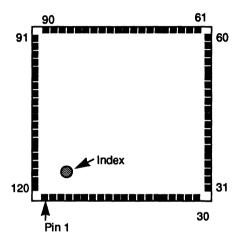


Figure 4.1 L64853 Pin Diagram (Top View)

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Pin	Abbreviation	Pin	Abbreviation	Pin	Abbreviation	Pin	Abbreviation
1	SLOW	31	D_D7	61	VDD	91	VSS
2	TEST	32	D_D6	62	E_AD1	92	INTREQ
3	OD_TST	33	D_D5	63	E_AD0	93	D8
4	PA3	34	D_D4	64	E_AD13	94	D9
5	PA2	35	D_D3	65	E_AD14	95	D10
6	PA1	36	D_D2	66	E_AD15	96	D11
7	VDD	37	D_D1	67	E_AH16	97	D12
8	VSS	38	D_D0	68	E_AH17	98	D13
9	PAX	39	D_RESET	69	E_AH18	99	D14
10	PAY	40	D_IRQ	70	E_AH19	100	D15
11	LERR	41	D_CS	71	VSS	101	D16
12	BG	42	VSS	72	VDD	102	D17)
13	BR	43	VDD	73	E_AH20	103	unconnected
14	ACK0	44	CLK	74	E_AH21	104	VDD
15	ACK2	45	D_RD	75	E_AH22	105	VSS
16	SIZ2	46	$\overline{\mathrm{D_WR}}$	76	E_AH23	106	D18
17	SIZ1	47	D_REQ	77	ACK1	107	D19
18	SIZ0	48	D_ACK	78	RESET	108	D20
19	VDD	49	E_AD12	79	RD	109	D21
20	unconnected	50	E_AD11	80	VSS	110	D22
21	ID_CS	51	E_AD10	81	SEL	111	D23
22	E_BYTE	52	VSS	82	AS	112	D24
23	E_CS	53	E_AD9	83	D0	113	D25
24	E_READ	54	E_AD8	84	D1	114	VSS
25	E_HLDA	55	E_AD7	85	D2	115	D26
26	E_HOLD	56	E_AD6	. 86	D3	116	D27
27	E_AS	57	E_AD5	87	D4	117	D28
28	E_DAS	58	E_AD4	88	D5	118	D29
29	E_RDY	59	E_AD3	89	D6	119	D30
30	VSS	60	E_AD2	90	D7	120	D31

Table 4.1 Signal Summary

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4.2 **Signal Descriptions**

For ease of reference, the signal descriptions are divided into four functional groups: D channel, E channel, SBus interface, and miscellaneous. Within each group, the signals are listed alphabetically by abbreviation. The SBus interface descriptions are minimal; the reader is referred to The SBus Specification for additional information.

D Channel Signals

These D channel signals define an interface to an external 8-bit controller chip:

D_DACK DMA Acknowledge. (Output buffer, active low, 3-state, CMOS, 4 mA output drive, Pin 48.)

> DMA Acknowledge is used to notify the 8-bit controller when it has been granted a DMA read or write cycle; that is, when it is time for the 8-bit controller to transfer data through the L64853 to or from the SBus. DMA Acknowledge and DMA Chip Select must never be active at the same time.

 D_CS DMA Chip Select. (3-state output buffer, active low, CMOS, 4 mA output drive, Pin 41.)

> DMA Chip Select is used to select the 8-bit controller as an I/O device; that is, to read or write the 8-bit controller's internal registers. DMA Chip Select and DMA Acknowledge must never be active at the same time.

D D[7:0] DMA Data Bus. (Bidirectional buffer, active high, TTL input levels, internal pulldown, 4 mA output drive, Pins 31-38.)

> Data lines D_D[7:0] connect the 8-bit controller and the L64853. They send data to and from the D channel Pack/Unpack Registers in the L64853 or send data through internal L64853 logic where it emerges as the lower 8 bits of the 32-bit L64853 data bus. These signals also serve as the input for external ID data when \overline{ID} is asserted (\overline{D} must also be asserted).

 \overline{D} IRQ DMA Interrupt Request. (Input buffer, active low, TTL level, non-inverting, internal pullup, Pin 40.)

> DMA Interrupt Request is pulled low when the 8-bit controller signals an interrupt; for instance, when a data transfer is completed and the 8-bit controller signals the completion to the L64853.

 \overline{D} \overline{RD} DMA Read Strobe. (3-state output buffer, active low, CMOS, 4 mA output drive, Pin 45.)

> The L64853 uses DMA Read Strobe to signal a read access to the 8-bit controller. This signal is used both for reading 8-bit controller internal registers and during actual data transfers from the D channel controller through the L64853 to the SBus (that is, during a memory write). DMA Chip Select or DMA Acknowledge must also be active.

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D_REQ

DMA Request. (Input buffer, active high, TTL level, non-inverting, Pin 47.)

DMA Request is used by the D channel controller to request that it be allowed to perform a DMA operation.

D_RESET

DMA Reset. (3-state output buffer, active high, CMOS, 4 mA output drive, Pin 39.)

DMA Reset is an output that can be used to clear the 8-bit controller.

D WR

DMA Write Strobe. (3-state output buffer, active low, CMOS, 4 mA output drive, Pin 46.)

The L64853 uses DMA Write Strobe to signal a write access to the 8-bit controller. This signal is used both for writing 8-bit controller internal registers and during actual data transfers from the D channel controller through the L64853 to the SBus (that is, during a memory read). DMA Chip Select or DMA Acknowledge must also be active.

ID_CS

Secondary Device Select. (Bidirectional buffer, active low, TTL input levels, 4 mA output drive, Pin 21.)

The Secondary Device Select line is pulled high to specify the existence of an external PROM. The DMA Data Bus lines are the input for $\overline{\text{ID}_\text{CS}}$ ($\overline{\text{D}_\text{RD}}$ must also be asserted). For more details about such a PROM, see *The SBus Specification*.

SLOW

Fast/Slow DMA Acknowledge Cycles. (Input buffer, active low, TTL level, non-inverting, internal pullup, Pin 1.)

The SLOW signal is used to specify either fast or slow mode. The pin controls transfer speed on the D channel. Fast mode must be used with the ESP SCSI controller. This signal requires no external connection. When SLOW equals ground (GND), two delay cycles are added.

E Channel Signals

These E channel signals define an interface to an external 16-bit E channel controller chip:

E_AD[15:0]

E Channel Address/Data Bus. (Bidirectional buffer, active high, TTL input levels, internal pullup, 4 mA output drive, Pins 49-51, 53-60, 62-66.)

E_AD[15:0] are address/data bus lines connecting the E channel controller and the L64853. These lines send data to and receive data from the E channel Pack/Unpack Registers in the L64853 or send data through internal L64853 logic, where it emerges as the lower half word of the 32-bit L64853 data bus. These lines also send the lower 16 bits of virtual addresses to the address latch in the L64853. For register reads/writes, the E channel controller is the driver.

E_A[23:16]

E Channel Address. (Input buffer, active high, TTL level, non-inverting, internal pulldown, Pins 67-70, 73-76.)

Lines E_A[23:16], which contain the upper 8 bits, together with the E Channel Address/Data Bus 15-0 lines, contain the 24-bits of a virtual address.

E AS

E Channel Address Strobe. (Input buffer, active low, TTL level, non-inverting, internal pulldown, Pin 27.)

E Channel Address Strobe can be driven low by the E channel controller to signal that an address transfer is taking place.

E_BYTE

E Channel Byte Marker. (Input buffer, active high, TTL level, non-inverting, internal pullup, Pin 22.)

When high, E Channel Byte Marker specifies that a byte transfer is taking place on the data lines (E Channel Address/Data 15:0); when clear, it indicates that a half-word transfer is taking place. The lowest bit of the address determines which byte is effective, if (E Channel Byte Marker) is set:

 $E_BYTE \quad E_AD(0)$

high high low high lower byte

upper byte

E_CS

E Channel Chip Select. (3-state output buffer, active low, CMOS, 4 mA output drive, Pin 23.)

E Channel Chip Select is used to select the E channel controller as an I/O device; that is, to read or write the E channel controller's internal registers.

E_DAS

E Channel Data Strobe. (Bidirectional buffer, active low, TTL input levels, internal pullup, 4 mA output drive, Pin 28.)

E Channel Data Strobe is high during the address portion of a memory access and low during the data portion. This signal is used to specify that a data transfer is taking place. This signal is driven by the L64853 for slave accesses.

E_HLDA

E Channel Hold Acknowledge. (3-state output buffer, active low, CMOS, 4 mA output drive, Pin 25.)

The L64853 uses E Channel Hold Acknowledge to acknowledge a prior E Channel Hold signal from the E channel controller, and thus to signal the controller to proceed with a DMA transfer.

E_HOLD

E Channel Hold. (Input buffer, active low, TTL level, non-inverting, internal pullup, Pin 26.)

E Channel Hold is asserted by the E channel controller when it requires access to memory. E Channel Hold is held low for the entire ensuing bus

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transaction. Once E Channel Hold goes inactive (high), so does E Channel Hold Acknowledge.

E_RDY

E Channel Ready. (Bidirectional buffer, TTL input levels, internal pullup, 4 mA output drive, Pin 29.)

The E Channel Ready strobe can be used in conjunction with the data lines to signal a data transfer.

E_READ

E Channel Read. (Bidirectional buffer, active high, TTL input levels, internal pullup, 4 mA output drive, Pin 24.)

E Channel Read indicates the type of operation to be performed in the current bus cycle. When high, E Channel Read signals a read from the memory to the controller. When low, it signals a write from the controller to the memory. This signal is driven by the L64853 during slave accesses.

SBus Interface Signals

These SBus signals interface the L64853 to the other system components:

PA[X:Y] SBus Physical Address X:Y. (input buffer, active high, TTL level, non-inverting, internal pullup, Pins 9-10.)

SBus Physical Address X and SBus Physical Address Y are two address lines (x and y) used for slave cycle address decodes.

PA[3:1] SBus Physical Address. (input buffer, active high, TTL level, non-inverting, internal pullup, Pins 4-6.)

Three lines, SBus Physical Address, are used to carry physical address signals.

ACK1 SBus Acknowledge 1. (Bidirectional buffer, active low, TTL input levels, inverting, internal pullup, 4 mA output drive, Pin 77.)

SBus Acknowledge 1 is used to acknowledge an 8-bit slave cycle.

ACK2 SBus Acknowledge 2. (Bidirectional buffer, active low, TTL input levels, inverting, internal pullup, 4 mA output drive, Pin 15.)

SBus Acknowledge 2 is used to acknowledge a 32-bit slave cycle.

AS SBus Address Strobe. (Input buffer, active low, TTL level, non-inverting, internal pullup, Pin 82.)

SBus Address Strobe low signals the address is valid.

 \overline{BG} SBus Bus Grant. (Input buffer, active low, TTL level, non-inverting, internal pullup, Pin 12.) A low SBus Bus Grant signals that the CPU has granted control of the SBus to the L64853. \overline{BR} SBus Bus Request. (3-state output buffer, active low, CMOS, 4 mA output drive. Pin 13.) To perform a master cycle, the L64853 first drives SBus Bus Request low to request control of the SBus bus from the CPU. CLK SBus Clock. (input clock driver, Pin 44.) The SBus Clock signal controls internal operations and rates of data transfer. It is usually derived from the master system clock or an associated CPU clock. D[31:0] SBus Data Bus. (Bidirectional buffer, TTL input levels, internal pullup, 4 mA output drive, Pins 83-90, 93-102, 106-113, 115-120.) Lines D[31:0] are the data lines of the SBus. ACK₀ SBus Acknowledge 0. (Bidirectional buffer, active low, TTL input levels, inverting, internal pullup, 4 mA output drive, Pin 14.) SBus Acknowledge 0 is used to report errors. **INTREO** SBus Interrupt Request. (Bidirectional buffer, active low, TTL input levels, open drain output, 4 mA output drive, Pin 92.) SBus Interrupt Request is the SBus interrupt line. It is activated when INT_EN is set and an external interrupt or various error conditions on the L64853 occur. **LERR** SBus Late Error. (Input buffer, active low, TTL level, non-inverting, internal pullup, Pin 11.) SBus Late Error is an error line. RD SBus Read/Write. (Bidirectional buffer, low = write, 3-state, TTL input levels, internal pullup, 4 mA output drive, Pin 79.) SBus Read/Write is used to signal the direction of data transfers on the SBus (reads or writes). RESET SBus Reset. (Input buffer, active low, TTL level, non-inverting, internal pullup, Pin 78.) SBus Reset is the SBus reset line.

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SEL	SBus Select. (Input buffer, active low, TTL level, non-inverting, internal pullup, Pin 81.)
	SBus Select is the slave select line specific for the L64853.
SIZ[2:0]	SBus Transfer Size. (Bidirectional buffer, active high, TTL input levels, internal pullup, 4 mA output drive, Pins 16-18.)
	The SIZ[2:0] lines are used to specify the size of the data transfer on the SBus: 8 bit, 16 bit, or 32 bit.

Miscellaneous Signals

OD_TST	Parametric Test Output. (3-state output buffer, active high, CMOS, 4 mA output drive, Pin 3.)
	OD_TST is a test line.
TEST	Test Control. (Input buffer, active low, CMOS level, non-inverting, internal pullup, Pin 2.)
	When low, Test Control enables parametric test output and disables all 3-state drivers. When high, TEST disables parametric test output.
VDD	Power. (Pins 7, 19, 43, 61, 72, 104.)
	There are six +5 volt power lines.
VSS	Ground. (Pins 8, 30, 42, 52, 71, 80, 91, 105, 114.)
	There are nine ground pins.

Pins 20 and 103 are not connected.

4.3 Data Transfer Cycles

The following descriptions and timing diagrams refer to relative timing relationships of L64853 signals during basic operations. For exact timing information, refer to the composite timing diagrams in **Chapter 5:** Specifications.

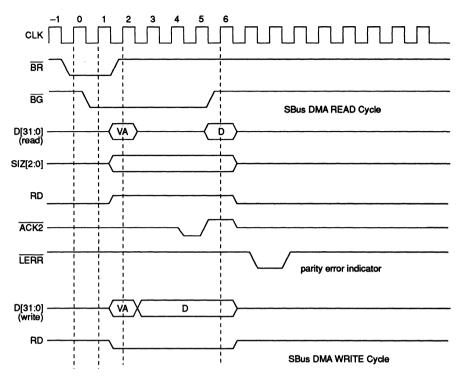
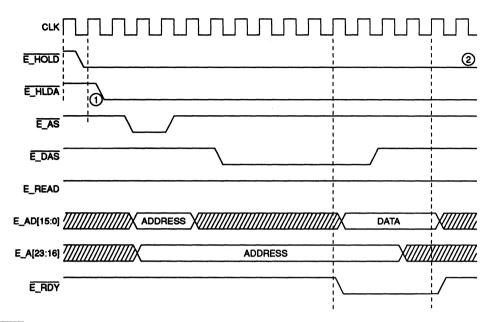


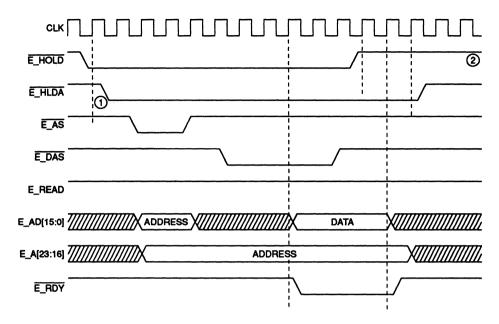
Figure 4.2 SBus DMA Read/Write

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- 1. E_HLDA is asserted only when the interface is not busy.
- 2. E_HOLD stays asserted for burst mode accesses. E_HLDA must follow it.

Figure 4.3 E Channel DMA Read Cycle (Data not in Pack/Unpack Register)



- 1. E_HLDA is asserted only when the interface is not busy.
- 2. E_HOLD stays asserted for burst mode accesses. E_HLDA must follow it.

Figure 4.4 E Channel DMA Read Cycle (Data in Pack/Unpack Register)

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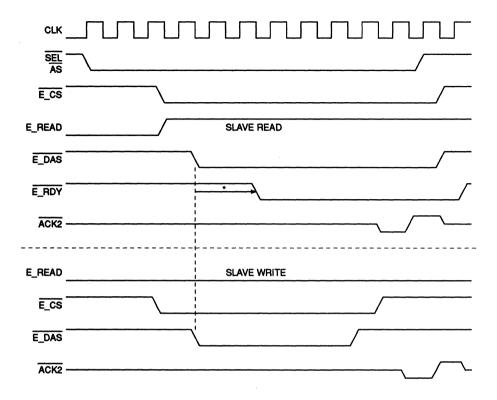
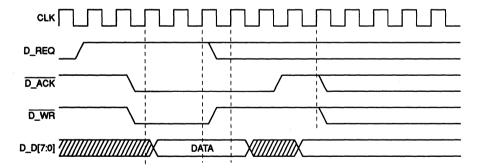
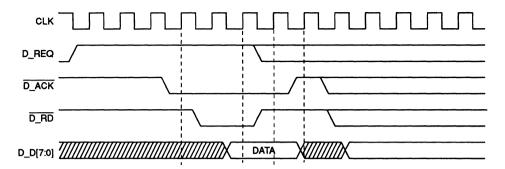


Figure 4.5 E Channel Register Read/Write Cycles



- 1. A Read indicates a transfer from memory to DMA device.
- 2. Data is available in Unpack Register. When Unpack Register is empty a memory read must occur to lengthen this operation (see SBus Read Cycle).

Figure 4.6 D Channel DMA Read—Fast Cycle



1. A Write indicates a transfer from DMA device to memory.

Figure 4.7 D Channel DMA Write—Fast Cycle

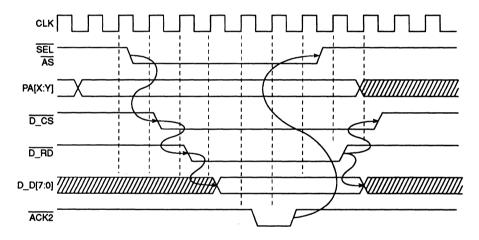


Figure 4.8 D Channel Register Read—Fast Cycle

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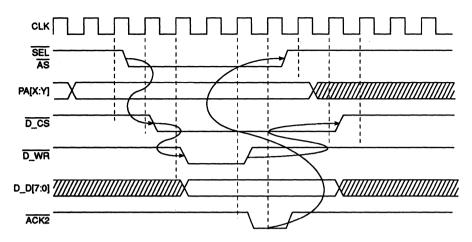
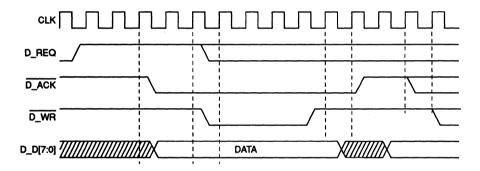


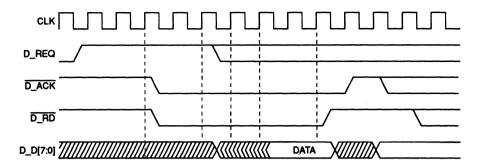
Figure 4.9 D Channel Register Write—Fast Cycle



- 1. A Read indicates a transfer from memory to DMA device.
- 2. Data is available in Unpack Register.

Figure 4.10 Extended D Channel DMA Read—Slow Cycle

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1. A Write indicates a transfer from DMA device to memory.

Figure 4.11 Extended D Channel DMA Write—Slow Cycle

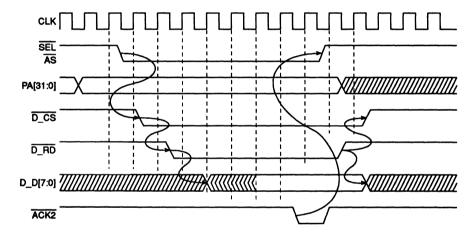


Figure 4.12 Extended D Channel DMA Register Read—Slow Cycle

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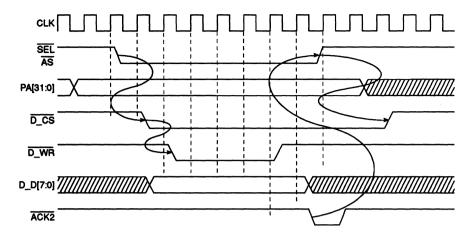


Figure 4.13 Extended D Channel DMA Register Write—Slow Cycle

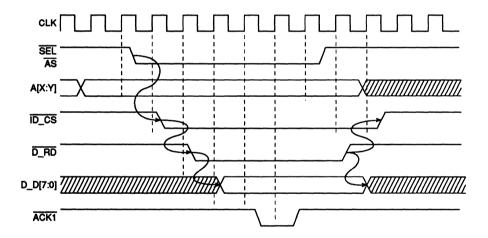


Figure 4.14 Offboard ID Read—Fast Cycle

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Chapter 5: Specifications

This chapter provides the AC, DC, environmental, and mechanical specifications of the L64853. This chapter is of use to hardware designers.

5.1 AC Characteristics

The AC characteristics described in the following section apply for $V_{DD} = 5V$, and TA = 25. Values are in nanoseconds unless otherwise stated.

			(Pro	pagation De	elays)	
Symbol	Input	1	l5 pf	50 pf	85 pf	100 pf
BR, E_HLDA						
E_CS, D_ACK,						
D_RD, D_WR,						
D_CS, D_RESET	tPHL		2.6	4.1	5.6	6.2
	tPLH		2.4	4.6	6.9	7.8
D[31:0], ACKO,						
RD, <u>INTREQ</u> ,						
SIZ[2:0], E_READ,						
E_DAS, E_RDY,	!					
E_AD[15:0], D_D[7:0],						
ACK2	tPHL		2.7	4.1	5.6	6.3
	tPLH		2.4	4.7	6.9	7.8
BG, RESET,						
LERR, SEL,						
AS , PA[X:Y],						
$PA[3:1], \overline{E}AS,$						
E_HOLD, E_BYTE,		Standard Loads				
E_A[23:16], <u>D_REQ</u> ,		1	2	3	4	5
D_IRQ	tPHL	0.7	0.7	0.7	0.7	8
	tPLH	0.8	0.8	0.9	0.9	1.1

Table 5.1 Signal Propagation Delays

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Switching Characteristics

No.	Signal	Description	Conditions	Min.	Max.	Units
1	CLK	clock period		30.0		ns
2		clock high				ns
3		clock low				ns
4	Note 1	hold wrt CLK		0.0		ns
5	Note 1	setup to CLK [^]		14.0		ns
6	Note 1	setup to CLK [^]		23.0		ns
7	Note 1	hold wrt CLK [^]		5.0		ns
8	Note 1	setup to CLK [^]		13.5		ns
9	Note 1	hold wrt CLK [^]		0.0		ns
10	Note 1	CLK [^] to output valid	load= 100pf		30.4	ns
11	Note 1	CLK [^] to output invalid	load= 100pf		22.0	ns
12	Note 1	CLK [^] to output valid	load= 130pf		31.4	ns
13	Note 1	CLK [^] to output invalid	load= 130pf		19.7	ns
14	Note 1	CLK [^] to output low	load= 100pf		24.0	ns
15	Note 1	CLK [^] to output high	load= 100pf		18.5	ns
16	D_REQ	setup to CLK [^]		0.0		ns
17	D_REQ	hold wrt CLK		3.7		ns
18	D_D[7:0]	setup to CLK		2.0		ns
19	D_D[7:0]	hold wrt CLK		3.5		ns
20	D_IRQ	setup to CLK [^]		0.0		ns
21	D_IRQ	hold wrt CLK		4.0		ns
22	D_RD	CLK [^] to output low	80pf		25.5	ns
23	D_RD	CLK [^] to output high	80pf		20.0	ns
24	D_WR	CLK [^] to output low	80pf		22.5	ns
25	D_WR	CLK [^] to output high	80pf		18.0	ns
26	D_D[7.0]	CLK [^] to output valid	80pf		29.0	ns
	 equals cloc 	k high			~	

Table 5.2 L64853 Switching Characteristics (Part 1 of 3)

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No.	Signal	Description	Conditions	Min.	Max.	Units
27	D_D[7.0]	CLK [^] to output invalid	80pf		21.0	ns
28	Note 2	CLK [^] to output low	80pf		24.0	ns
29	Note 2	CLK [^] to output high	80pf		19.0	ns
30	Note 3	D_RD to D_D[7:0] valid			50.0	ns
31	Note 3	D_RD to D_D[7:0] invalid		0.0		ns
32	D_RESET	CLK [^] to output low	80pf		20.0	ns
33	D_RESET	CLK [^] to output high	80pf		18.0	ns
34	D_ACK	CLK [^] to output low	80pf		23.5	ns
35	D_ACK	CLK [^] to output high	80pf		17.0	ns
36	E_AD[15:0]	setup to CLK [^] (Note 4)			1.0	ns
37	E_AD(15.0)	hold wrt to CLK [^] (Note 4)		4.0		ns
38	E_AD(15:0)	CLK [^] to output valid	80pf		36.0	ns
39	E_AD(15:0)	CLK [^] to output invalid	80pf		25.0	ns
40	E_HLDA	CLK [^] to output high	80pf		18.0	ns
41	E_HLDA	CLK [^] to output low	80pf		21.5	ns
42	E_READ	CLK [^] to output valid	80pf		15.5	ns
43	E_READ	CLK [^] to output invalid	80pf		12.0	ns
44	E_DAS	CLK [^] to output valid	80pf		23.0	ns
45	E DAS	CLK [^] to output invalid	80pf		18.5	ns
46	E_RDY	CLK [^] to output valid	80pf		23.0	ns
47	E_RDY	CLK [^] to output invalid	80pf		17.5	ns
48	E_CS	CLK [^] to output high	80pf		15.0	ns
49	E_CS	CLK [^] to output low	80pf		20.0	ns
50	E_RDY	setup to CLK [^]			0.0	ns
51	E_RDY	hold wrt to CLK			2.8	ns
52	E_AD[15:0]	ADDR setup to E_AS low			15.0	ns
53	E_AD[15:0]	ADDR hold wrt E_AS high			0.0	ns
54	E_HOLD	setup to CLK [^]			0.0	ns
55	E_HOLD	hold wrt to CLK [^]			4.0	ns

Table 5.2 L64853 Switching Characteristics (Part 2 of 3)

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No.	Signal	Description	Conditions	Min.	Max.	Units
56	Note 1	setup to CLK ^A		0.0		ns
57	Note 1	hold wrt to CLK [^]		3.0		ns
58	Note 2	hold wrt to CLK [^]		0.0		ns

- Note 1: The values in Table 5.2 represent the timing characteristics of groups of signals. The timing diagrams show that one mnemonic value can represent many different signal paths.
- Note 2: These timing parameters are true for both the signals $\overline{D_-CS}$ and $\overline{ID_-CS}$.
- Note 3: The documented values represent the timing of an external device (in this case the ESP SCSI CHIP).
- Note 4: The setup and hold times refer to the timing diagram on which they are shown, and in particular to the clock edges shown. Internal to the chip, the E_AD bus is not latched for at least 2 clock cycles to alleviate any potential timing problems; consequently, the 0 ns timing requirements shown are true only if the cycle-by-cycle handshaking specified by the LANCE is maintained.

Table 5.2 L64853 Switching Characteristics (Part 3 of 3)

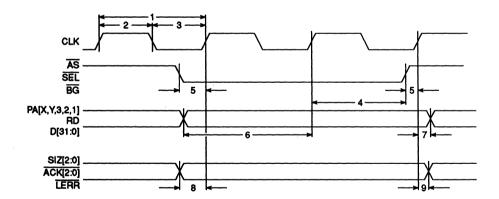


Figure 5.1 SBus Input Signals

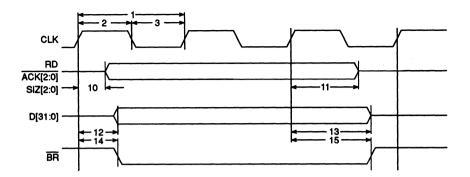


Figure 5.2 SBus Output Signals

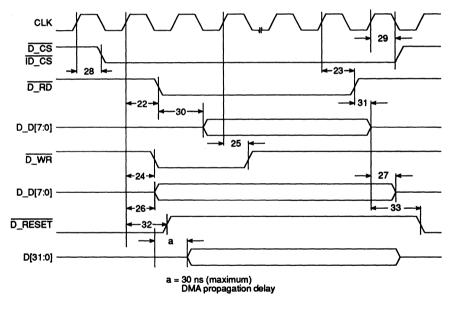


Figure 5.3 DMA Data Bus Read/Write Cycle Timing (Fast Cycle)

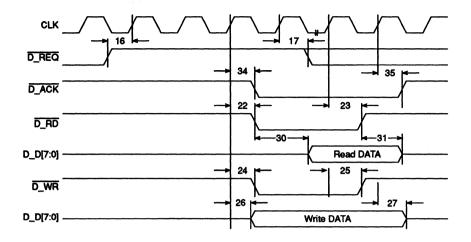
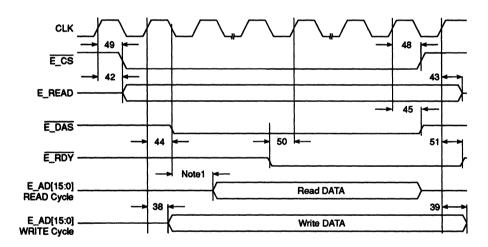
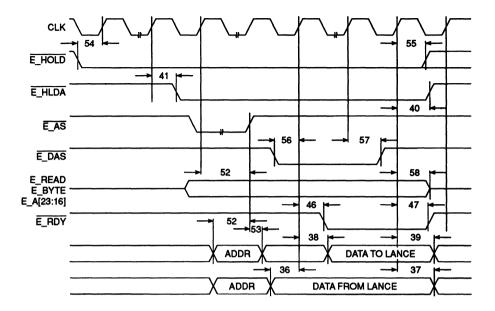


Figure 5.4 DMA Data Bus DMA Cycle Timing (Fast Cycle)



 Refer to the AMD Am7990 LANCE Ethernet Controller manual or product specification for timing specifications.

Figure 5.5 LANCE Read/Write Cycle Timing



1. Refer to the AMD Am7990 LANCE Ethernet Controller manual or product specification for timing specifications.

Figure 5.6 LANCE DMA Read/Write Cycle Timing

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5.2 DC Characteristics

This section specifies the DC electrical requirements for the L64853 DMA Controller. These requirements are listed in the following tables:

- Absolute Maximum Ratings
- Recommended Operating Conditions
- DC Characteristics

Parameter	Symbol	Limits	Unit	
DC Supply Voltage	V _{DD}	-0.3 to +7	V	
Input Voltage	V _{IN}	-0.3 to VDD +0.3	V	
DC Input Current	I _{IN}	±10	μΑ	
Storage Temperature Range T _{STG} -40 to +125 °C				
References to V _{SS}				

Table 5.3 Absolute Maximum Ratings

Parameter	Symbol	Limits	Unit
DC Supply Voltage	V _{DD}	0 to +5.25	V
Commercial (operating ambient temperature)	T _{STG}	0 to +70	°C

Table 5.4 Recommended Operating Conditions

Symbol	Parameter	Condition	Min	Тур	Max	Units
v _{IL}	Voltage Input LOW TTL inputs				0.8	v
v _{IH}	Voltage Input HIGH TTL Inputs				2.0	v
V _T +	Schmitt Trigger, Positive-Going Threshold			3.0	4.0	V
v _T -	Schmitt Trigger, Negative-Going Threshold		1.0	1.5		V
П	Hysteresis, Schmitt Trigger	V _{IL} to V _{IH} V _{IH} to V _{IL}	1.0	1.5		V
I _{IN}	Input Current, CMOS, TTL Inputs Inputs with Pulldown Resistors Inputs with Pullup Resistors	$V_{IN} = V_{DD}$ or V_{SS} $V_{IN} = V_{DD}$ $V_{IN} = V_{SS}$	-10 10 -100	±1 35 -30	10 120 -8	μΑ μΑ μΑ
V _{OH} (TTL)	Voltage Output HIGH	I _{OH} = -4.0 mA	2.4	4.5		V
V _{OL}	Voltage Output LOW	I _{OL} = -4.0 mA		0.2	0.4	v
IOZ	3-State Output Leakage Current	$V_{OH} = V_{DD}$ or V_{SS}	-10	±1	10	μΑ
Ios	Current Open Short Circuit Current ¹	$V_{DD} = Max, V_{O} = V_{DD}$ $V_{DD} = Max, V_{O} = O_{V}$	15 -5	50 -25	130 -100	mA mA
C _{IN}	Input Capacitance	Any input ²		2		ρf
COUT	Output Capacitance	Any Output ³		4		ρf

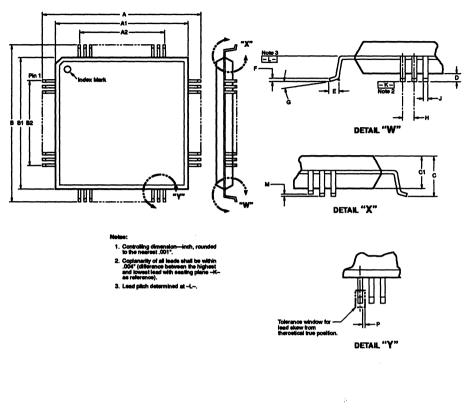
¹Not more than one output may be shorted at a time for a maximum duration of one second.

²Not applicable to assigned bidirectional buffer.

³Output using single buffer structure.

Table 5.5 DC Characteristics

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	Min	1.244 (31.60)
_	Max	1.276 (32.40)
A1	Min	1.098 (27.90)
^'	Max	1.106 (28.10)
A2	Ref	0.913 (23.20)
В	Min	1.244 (31.50)
Ü	Max	1.276 (32.40)
B1	Min	1.098 (27.90)
	Max	1.106 (28.10)
B2	Ref	0.913 (23.20)
С	Max	0.152 (3.85)
C1	Max	0.138 (3.50)
D	Max	0.012 (0.30)
E	Min	0.024 (0.060)
	Max	0.039 (1.00)
F	Min	0.004 (0.10)
Ĺ	Max	0.010 (0.25)
G	Min	0°
	Max	10°
н	Nom	0.31 (0.80)
	Min	0.10 (0.25)
Ľ	Max	0.018 (0.45)
М	Max	0.004 (0.10)
Р	Max	0.002 (0.05)

Dimensions

inches (mm)

Figure 5.7 120-Pin PQFP Dimension Drawing

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Chapter 6: Applications

This chapter provides information on using the L64853 DMA Controller in two types of SPARC Workstation environments and also describes how the controller can be configured with two peripheral chips: the AMD Am7990 LANCE Ethernet Controller and the Emulex SCSI Processor ESP-100. Both peripheral chips can be configured with the L64853 DMA Controller without additional circuitry to offer a low chip-count solution for networking and hard disk requirements.

For more information on these chips, refer to the appropriate documentation from Advanced Micro Devices, Inc. and Emulex Corporation, respectively.

6.1 The SBus and the SPARC Workstation

The L64853 has been developed for use with the SPARC family of chips. As such, it fits into one of two distinct kinds of SPARC Workstation environments: a host-based system and a symmetric system.

In a host-based system the CPU has a private address translation facility (in SBus terminology, this kind of system has a "CPU Master"). Host-based architectures are applicable in very high performance systems, such as the Sun SPARCstation 1, in which the SBus should be used only as a high-performance I/O interface and not as the CPU's channel to main memory. Figure 6.1 shows a typical host-based configuration.

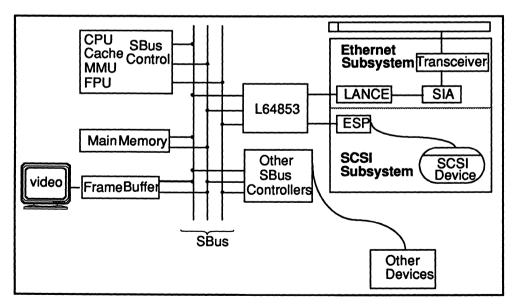


Figure 6.1 Host-Based System: SPARCstation 1

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In a symmetric system, the CPU uses the same MMU as all the other SBus Masters (in SBus terminology, all SBus Masters in this kind of system are "DVMA Masters"). This type of architecture can be useful in low cost systems that don't need the extra circuitry that supplies the CPU with special address translation facilities. Figure 6.2 shows a symmetric system.

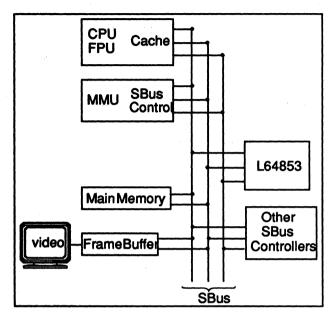


Figure 6.2 Symmetric Configuration

6.2 Using the L64853 With the EMULEX ESP100 SCSI Processor

This section illustrates the electrical interface for using the L64853 with the Emulex ESP100; it also shows how to access the ESP's internal registers.

Electrical Interface

The interface between the L64853 and the Emulex ESP100 is straightforward, and requires no additional logic. Figure 6.3 illustrates the interface.

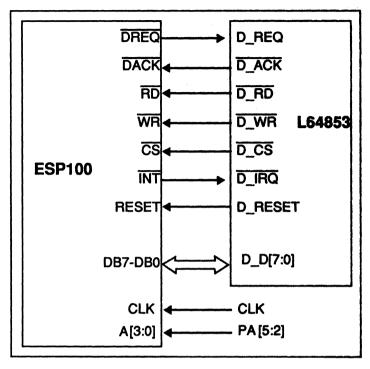


Figure 6.3 L64853 to ESP100 Interface

Figure 6.4 shows an ESP interface example using an external boot PROM.

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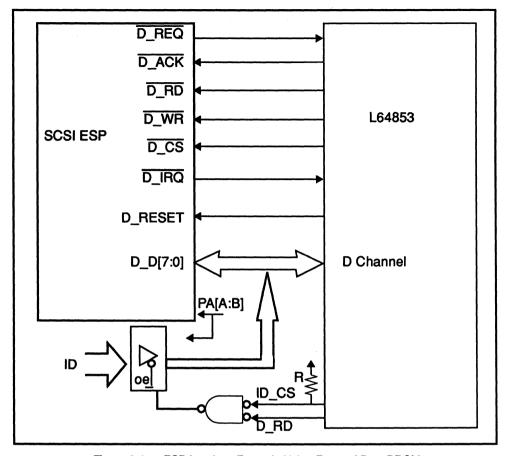


Figure 6.4 ESP Interface Example Using External Boot PROM

Accessing ESP Internal Registers

Table 6.1 shows how the physical address lines of the SBus on the SPARCstation 1 are wired to select the external registers of the ESP SCSI chip (note that "x" means either 1 or 0).

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PA[X:Y] = PA[23:22]	PA[5:2]	PA1
10	0000 0001 0010 0011 0100 0101 0110 0111 1000 1001 1010 1011 11xx	x Transfer Count Low x Transfer Count High x FIFO Data x Command x Status/Bus ID x Interrupt/Status Timeout x Seq.step/Synch transfer period x FIFO flags/Synch offset x Configuration x Clock Conversion Factor x ESP TEST x Configuration x Reserved

Table 6.1 Physical Address Line Wiring on SBus for Selecting External Registers on ESP SCSI Chip

Notes:

- The Enable Counter (bit 13) of the DMA Control/Status Register is not used with the ESP SCSI Controller.
- 2. The DMA Byte Counter Register is not used with the ESP SCSI Controller, which has its own Byte Counter external register.

6.3 Using the L64853 (With the AMD LANCE Ethernet Controller)

This section illustrates the electrical interface of the L64853 with the AMD Am7990 and shows how to access the LANCE's internal registers.

Electrical Interface

The interface between the L64853 and the LANCE is straightforward and requires no additional logic. Figure 6.5 illustrates the interface.

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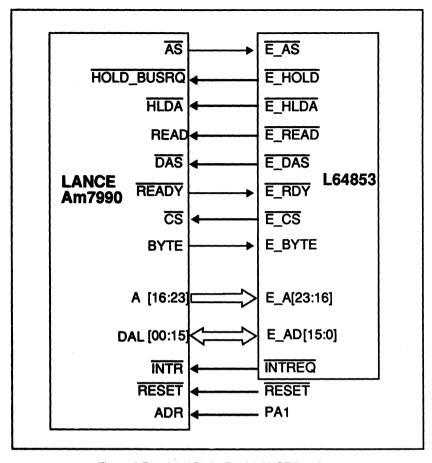


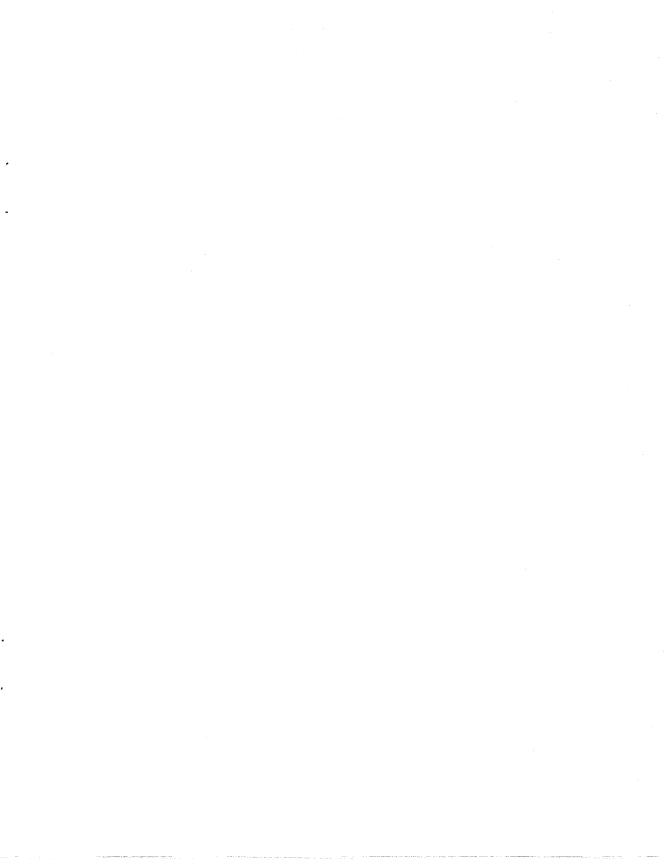
Figure 6.5 L64853 Am7990 LANCE Interface

Accessing LANCE Internal Registers

Table 6.2 shows how the physical address lines of the SBus on the SPARCstation 1 are wired up to select the external registers of the LANCE Ethernet chip (note that "x" means either 1 or 0).

PA[X:Y] = PA[23:22]	PA1
11	0 Register Data Port (RDP)

Table 6.2 Wiring of SBus Physical Address Lines for Selecting External Registers on LANCE ETHERNET Chip



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